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PTO/SB/08 Equivalent

	Application No.	10/590,046
INFORMATION DISCLOSURE	Filing Date	June 15, 2007
STATEMENT BY APPLICANT	First Named Inventor	Hirayama et al.
	Art Unit	1795
(Multiple sheets used when necessary)	Examiner	Johnson, C.
SHEET 1 OF 2	Attorney Docket No.	SHIGA7.055APC

	U.S. PATENT DOCUMENTS					
Examiner Initials	Cite No.	Document Number Number - Kind Code (if known) Example: 1,234,567 B1	Publication Date MM-DD-YYYY	Name of Patentee or Applicant	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear	
	1	2004/0234885 A1	11-25-2004	Watanabe et al.		
	2	2002/0058205 A1	05-16-2002	Nakashima et al.		
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	6	JP-A-2004-191913	07-08-2004	Idemitsu Kosan Co Ltd.		Abstract
	7	JP-A-2003-084437	03-19-2003	Toray Ind Inc		✓
	8	JP-A-2002-328473	11-15-2002	JSR Corp		✓
	9	JP-A-11-153863	06-08-1999	Toshiba Corp		Abstract
	10	JP H08-262712	10-11-1996	Japan Synthetic Rubber Co Ltd		Abstract

		NON PATENT LITERATURE DOCUMENTS	
Examiner Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T <sup>1</sup>
	11	Hirayama et al, "Development of Amorphous PolyPhenol Resists with Low Molecular Weight and Narrow Dispersion for EB Lithography", IEEE Xplore, October 22, 2004, pp. 10-11.	
	12	Notice of Allowance issued on corresponding Japanese Patent Application No. 2004-260764, dated February 16, 2010.	
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Examiner Signature	/Connie Joh	nson/ (07/01/2010)	

Date Considered 07/01/2010

\*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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	Application No.	10/590,046
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STATEMENT BY APPLICANT	First Named Inventor	Hirayama et al.
	Art Unit	1795
(Multiple sheets used when necessary)	Examiner	Johnson, C.
SHEET 2 OF 2	Attorney Docket No.	SHIGA7.055APC

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	10	26, 2010 (SHIGA7.073APC)	
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Date Considered 07/01/2010 Examiner Signature /Connie Johnson/ (07/01/2010) \*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not

in conformance and not considered. Include copy of this form with next communication to applicant.

ALL REFERENCES CONSIDERED EXCEPT WHERE

T¹ - Place a check mark in this area when an English language Translation is attached.